



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Yin et al.

**Serial No.:** 09/293,188

**Filed:** April 16, 1999

**For:** METHOD OF FORMING  
INTERCONNECT STRUCTURE WITH  
INTERLAYER DIELECTRIC (as amended)

**Confirmation No.:** 4546

**Examiner:** P. Cao

**Group Art Unit:** 2814

**Attorney Docket No.:** 2269-6910.1US  
(97-1121.01/US)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

March 10, 2006  
Date

  
Signature

Leta M. Howard  
Name (Type/Print)

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
PO Box 1450  
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed December 13, 2005, the three-month shortened statutory period for response to which expires on March 13, 2006.

**Amendments to the Title** appear on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**In the Drawings** begins on page 7 of this paper.

**Remarks** begin on page 8 of this paper.

**IN THE TITLE:**

The title has been amended herein. Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date), please enter the title as amended.

METHOD OF FORMING INTERCONNECT STRUCTURE WITH INTERLAYER  
DIELECTRIC